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by J. D. Clayton and R. H. Kraft

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J. D. Clayton and R. H. Kraft
Weapons and Materials Research Directorate, ARL

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MESOSCALE MODELING OF DYNAMIC FAILURE OF CERAMIC POLYCRYSTALS

J.D. Clayton
U.S. Army Research Laboratory
RDRL-WMP-B
Aberdeen Proving Ground, MD 21005-5066
USA
john.d.clayton1@us.army.mil

R.H. Kraft
U.S. Army Research Laboratory
RDRL-WMP-B
Aberdeen Proving Ground, MD 21005-5066
USA
reuben.kraft@us.army.mil

ABSTRACT

Mesoscale models are used to study dynamic deformation and failure in silicon carbide (SiC) and aluminum oxynitride (AlON) polycrystals. Elastic and anisotropic elastic-plastic crystal models represent mechanical behavior of SiC and AlON and grains, respectively. Cohesive zone models represent intergranular fracture. Failure data that can be used to inform macroscopic continuum models of ceramic behavior are collected and analyzed. Studied are effects of grain morphology, specimen size, and applied stress state on behavior of polycrystalline aggregates loaded dynamically at applied strain rates on the order of $10^5/s$. Results for SiC demonstrate shear-induced dilatation, increasing shear strength with increasing confinement or pressure, increasing strength with decreasing specimen size (in terms of number of grains), and decreasing strength variability with decreasing size. Results for AlON demonstrate increased initiation of slip activity—particularly in the vicinity of constrained grain boundaries—with confinement.

1. INTRODUCTION

Ballistic performance of a ceramic depends on a number of factors associated with the material response to high loading rates and high pressures that arise during impact¹⁻³. The performance difference of two monolithic ceramic materials of comparable mass density necessarily originates from microstructure: crystal structure and composition, grain morphology, grain boundaries, and defects such as pores, inclusions, and secondary phases. Crystal structure and composition affect bulk mechanical properties such as elastic stiffness, hardness, cleavage strength, dislocation slip resistance, twinning resistance, and possible phase transformations. Grain boundaries and defects can affect failure properties such as fracture toughness and spall strength.

Mesoscale modeling, wherein geometries of individual grains are resolved explicitly, offers insight into effects of microstructure on dynamic performance of polycrystalline solids. Previous modeling efforts on ceramics have often considered only two spatial dimensions⁴⁻⁶. The present representation is three-dimensional, extending work of Kraft et al.⁷ and Gazonas et al.⁸. In addition to AlON addressed previously^{7,8}, the present work considers SiC (specifically SiC-N, primarily consisting of the 6H polytype). AlON and SiC exhibit some noteworthy physical differences. SiC (α -phase, 6H) belongs to a hexagonal crystal system, while AlON (γ -phase) is cubic. Polycrystalline SiC is opaque, while polycrystalline AlON is transparent. SiC has a lower mass density and higher fracture strength and toughness than AlON, with a typical grain size smaller than that of AlON by a factor of ~ 40 . Upon optical examination, AlON⁹ appears to have fewer processing defects (e.g., voids and

inclusions) than SiC-N¹⁰. Both can exhibit limited plasticity under loading involving confining pressure: SiC by propagation of partial dislocations (and associated stacking faults) on {0001} basal planes^{11,12}, and AlON by glide of partial dislocations on {111} octahedral planes^{13,14}.

In addition to providing insight of effects of microstructure on performance, mesoscale modeling can yield information to motivate or parameterize macroscopic models that do not explicitly resolve features of the microstructure. Brittle materials are known to exhibit a size effect, wherein smaller samples are often stronger, typically assumed a result of a lower probability of containment of a critical flaw. Numerical failure modeling of brittle materials is also prone to mesh sensitivity. One representative macroscopic model that addresses issues of failure statistics and size effects is Kayenta^{15,16}. Statistics gathered from mesoscale computations can provide input to Kayenta failure surfaces. Mesoscale simulations can address small specimen sizes comparable to finite element sizes used in macroscopic representations, and can consider homogeneous boundary conditions not easily applied in standard characterization tests for failure of brittle materials. Limitations of the present approach are that polycrystalline samples comparable in size to those tested experimentally cannot be simulated directly due to computing constraints (particularly for SiC with its small grain size) so that validation of mesoscopic computations becomes difficult. Furthermore, a number of microscopic properties are not known precisely (e.g., grain boundary fracture properties), and their effects on macroscopic response must be estimated through extensive parameter studies^{4-6,17}.

This paper is organized as follows. Section 2 summarizes constitutive models for bulk behavior of single crystals of SiC and AlON. Section 3 summarizes fracture models for interfaces. Section 4 discusses microstructures represented in mesoscale finite element simulations of ceramic polycrystals. Sections 5 and 6 report on results for SiC and AlON, respectively. Section 7 concludes the paper.

2. CERAMIC SINGLE CRYSTALS: CONSTITUTIVE MODELING

Principles of continuum mechanics are used to represent mechanical behavior of individual grains within a ceramic polycrystal. Notational conventions of nonlinear continuum mechanics¹⁸ are used, with all vectors and tensors referred to a single fixed Cartesian coordinate system. Thermal effects are not considered. Local balances of mass, linear momentum, angular momentum, and energy are

$$\rho_0 = \rho J, \quad \nabla \cdot \mathbf{P} = \rho_0 \ddot{\mathbf{x}}, \quad \mathbf{P} \mathbf{F}^T = \mathbf{F} \mathbf{P}^T, \quad \dot{W} = \mathbf{P} : \dot{\mathbf{F}}, \quad (1)$$

where ρ_0 is the reference mass density, $\mathbf{F} = \nabla \mathbf{x} = \mathbf{I} + \nabla \mathbf{u}$ is the deformation gradient, ∇ is the referential gradient operator, \mathbf{I} is the unit tensor, $\mathbf{x}(\mathbf{X}, t) = \mathbf{X} + \mathbf{u}$ are spatial coordinates with \mathbf{u} the displacement, $J = \det \mathbf{F}$, \mathbf{P} is the first Piola-Kirchhoff stress, and W is the energy density. The deformation gradient and plastic velocity gradient can be written, respectively, as

$$\mathbf{F} = \mathbf{F}^E \mathbf{F}^P, \quad \mathbf{F}^P \dot{\mathbf{F}}^{P-1} = \sum_i \dot{\gamma}^i \mathbf{s}^i \otimes \mathbf{m}^i, \quad (2)$$

where \mathbf{F}^E accounts for elasticity and rigid rotation, \mathbf{F}^P accounts for plastic slip, and $\dot{\gamma}^i$, \mathbf{s}^i , and \mathbf{m}^i are the slip rate, slip direction, and slip plane normal for slip system i . Relations in (2) can be extended to account for deformation twins^{14,19,20} that may be of importance in AlON⁹; discussion of twinning models is omitted here for brevity. Internal energy density is

$$W = \hat{W}(\mathbf{E}^E) + f(\xi), \quad \mathbf{E}^E = (1/2)(\mathbf{F}^{ET} \mathbf{F}^E - \mathbf{I}), \quad (3)$$

where \hat{W} depends on elastic strain \mathbf{E}^E via second-order elastic constants and possibly higher-order elastic coefficients or pressure-sensitive second-order coefficients. Stress \mathbf{P} and Cauchy pressure p are

$$\mathbf{P} = \mathbf{F}^E (\partial W / \partial \mathbf{E}^E) \mathbf{F}^{P-T}, \quad p = -[1/(3J)] \text{tr}(\mathbf{F} \mathbf{P}^T). \quad (4)$$

In (3), function f accounts for contributions from defects such as dislocations, vacancies, stacking faults, and twin boundaries, and ξ is a generic internal state variable representing such defects. In the

absence of slip or defects, and when pressure dependence of elastic coefficients is omitted, (3)-(4) become the usual relations of a Kirchhoff-St. Venant hyperelastic solid with second-order moduli \mathbf{C} :

$$W = (1/2)\mathbf{E} : \mathbf{C} : \mathbf{E}, \quad \mathbf{E} = (1/2)(\mathbf{F}^T \mathbf{F} - \mathbf{I}), \quad \mathbf{P} = \partial W / \partial \mathbf{F} = \mathbf{F}(\partial W / \partial \mathbf{E}) = \mathbf{F}(\mathbf{C} : \mathbf{E}). \quad (5)$$

In the geometrically linear approximation, (5) is replaced with the familiar linear elasticity relations

$$W = (1/2)\boldsymbol{\varepsilon} : \mathbf{C} : \boldsymbol{\varepsilon}, \quad \boldsymbol{\varepsilon} = (1/2)[\nabla \mathbf{u} + (\nabla \mathbf{u})^T], \quad \mathbf{P} = \mathbf{P}^T = \partial W / \partial \boldsymbol{\varepsilon} = \mathbf{C} : \boldsymbol{\varepsilon} = \mathbf{C} : \nabla \mathbf{u}. \quad (6)$$

Kinetic equations for slip and possible strain hardening are of the functional form

$$\dot{\gamma}^i = \dot{\gamma}^i(\tau^i / \tau_c), \quad \tau_c / G = g(\xi), \quad \dot{\xi} = \dot{\xi}(\dot{\gamma}^i), \quad (7)$$

with τ^i the resolved Kirchhoff stress on shear system i , τ_c the shear strength that is assumed equal for all slip systems, G the shear modulus that can depend on pressure, and g a scalar function of dislocation density. More detailed forms of (7) are available elsewhere^{14, 19, 20}.

Mechanical properties are listed in Table 1 for the two ceramics studied in the present work. Supporting references with extensive lists of properties are available for SiC¹² and AlON¹⁴. Cubic elastic constants for AlON are available only from first-principles calculations^{7, 8, 21} and are subject to uncertainty, since values quoted have not been validated through experiments. Properties of SiC are representative of SiC-N manufactured by BAE³. Properties of AlON are representative of a standard composition having 35.7 mol % AlN²². Single crystals are elastically anisotropic; listed bulk and shear moduli and their pressure derivatives at the reference state are representative values for fully dense polycrystals. The initial dynamic slip resistance τ_c , in each material approximately 2% of effective shear modulus G , reflects the experimentally measured polycrystalline shear strength under impact conditions at or above the HEL (strain rate $\sim 10^5$ /s, pressure > 10 GPa)^{11, 14, 23}.

Table 1: Bulk mechanical properties of SiC and AlON

Property	SiC	AlON
Structure	6H	spinel
Phase	α	γ
Crystal system	hexagonal	cubic
Mass density ρ_0	3227 kg/m ³	3714 kg/m ³
Elastic constant C_{11}	501 GPa	377 GPa
Elastic constant C_{12}	112 GPa	133 GPa
Elastic constant C_{44}	161 GPa	125 GPa
Elastic constant C_{13}	52 GPa	(= C_{12})
Elastic constant C_{33}	549 GPa	(= C_{11})
Bulk modulus B	222 GPa	214 GPa
Shear modulus G	194 GPa	124 GPa
$B' = dB/dp$	3.10	4.20
$G' = dG/dp$	0.90	0.95
Primary slip plane	{0001}	{111}
Strength τ_c/G	0.022	0.019
Typical grain size	5 μm	200 μm

3. GRAIN BOUNDARY INTERFACES: FRACTURE MODELING

A cohesive zone model is used to represent intergranular (i.e. grain boundary) fracture. First consider mode I fracture. Crack opening initiates when resolved normal traction σ on an interface exceeds fracture strength σ_c . A simple cohesive law of the following form^{7, 8} then relates crack opening displacement δ and normal traction σ :

$$\sigma = \sigma_c(1 - \delta/\delta_c) \text{ [for } 0 < \delta/\delta_c < 1\text{]}; \sigma = 0 \text{ [for } \delta/\delta_c \geq 1\text{]}. \quad (8)$$

In the context of linear elastic fracture mechanics, fracture toughness K_c , surface energy Γ_c , strain energy release rate G_c , strength σ_c , critical separation δ_c , and cohesive zone length l_c are related by^{17, 24}

$$K_c^2(1 - \nu^2)/E = 2\Gamma_c = G_c = (1/2)\sigma_c\delta_c, \quad l_c = \pi E\Gamma_c / [\sigma_c^2(1 - \nu^2)], \quad (9)$$

where elastic modulus $E = 9BG/(3B + G)$ and Poisson's ratio $\nu = (3B - 2G)/(6B + 2G)$. Properties are listed in Table 2 for SiC^{3, 16} and AlON²⁵, estimated from flexure strength and static fracture toughness measurements. For comparison, spall strengths of SiC²⁶ and AlON²⁷ are also listed in Table 2; spall strength values are comparable to flexure strengths, though spall strengths are known vary considerably with impact pressure. Relations analogous to (8) and (9) are used to describe the relationship between shear traction and tangential crack opening (i.e., mode II/III fracture), with equivalent properties. In the finite element implementation of the fracture model, after complete interfacial separation ($\delta/\delta_c > 1$) occurs, interactions between grains are addressed via a multi-body contact algorithm in the SIERRA software framework²⁸ that prohibits interpenetration of material. Post-fracture contact is assumed frictionless.

More sophisticated cohesive laws with strength or toughness depending on mode mixity, loading rate, and/or temperature are available, and have been examined in detail elsewhere^{17, 24, 29}. Transgranular (i.e., cleavage) fracture within individual grains is not modeled in the present work. The assumption that dynamic fracture occurs predominantly at grain boundaries is appropriate for compositions of SiC (e.g., SiC-N) of present interest that fail statically and dynamically in an intergranular fashion^{10, 30} and was followed in a previous mesoscale model of spall fracture in SiC⁶. The assumption that dynamic fracture in AlON occurs predominantly at grain boundaries was used by Kraft et al.^{7, 8}, though recovered samples from dynamic compression experiments suggest cleavage occurs on {111} planes^{9, 13}. A two-dimensional numerical model of transgranular fracture in alumina has been implemented elsewhere⁴; a three-dimensional capability is unavailable in the finite element software²⁸ used in the present work for materials of current interest. All grain boundaries within a sample of a given material are assumed to have the same properties⁶⁻⁸. Fracture strength and/or toughness distributions are expected to exist in real materials (resulting from lattice misorientation distributions and grain boundary defects) and can affect computed macroscopic mechanical properties and failure statistics^{4, 5, 17}. As-processed polycrystalline SiC and AlON contain defects such as limited porosity, second-phase inclusions, and small micro-cracks^{10, 22}; explicit incorporation of such defects in mesoscale models will be investigated in future work. The present study focuses on effects of grain morphology, bulk material behavior (e.g., crystal structure, elasticity, and plasticity), applied stress state, and specimen size (i.e., number of grains).

Table 2: Fracture properties of SiC and AlON

Property	SiC	AlON
Fracture strength σ_c	570 MPa	306 MPa
Fracture toughness K_c	5.1 MPa m ^{1/2}	2.5 MPa m ^{1/2}
Surface energy Γ_c	28.1 J/m ²	9.4 J/m ²
Critical opening δ_c	0.197 μ m	0.122 μ m
Cohesive length l_c	125.8 μ m	104.8 μ m
Spall strength σ_s	0.54 GPa -1.3 GPa	0.14 GPa -1.7 GPa

4. MICROSTRUCTURAL REPRESENTATIONS

The procedure for generating grain geometries, employing methods and software developed by Rollett and colleagues³¹ is discussed in detail elsewhere⁷. Two finite element meshes, each of a

different microstructure, are considered here, as shown in Figure 1. Pertinent properties of each microstructure are listed in Table 3. Cumulative grain size distributions are shown in Figure 2; microstructure I displays a smaller variation in grain size than microstructure II, with more grains of size closer in size to the average grain size. Microstructure I features larger, more equiaxed grains, of more uniform size. Microstructure II features smaller grains, with more jagged grain boundaries. Microstructure I is deemed qualitatively representative of AlON (large equiaxed grains, smooth clean grain boundaries), while microstructure II is more representative of SiC-N (smaller grains, less uniformity, rough boundaries associated with grain boundary segregants). Mesh refinement is sufficient to fully resolve cohesive lengths and grain boundary surface morphology.

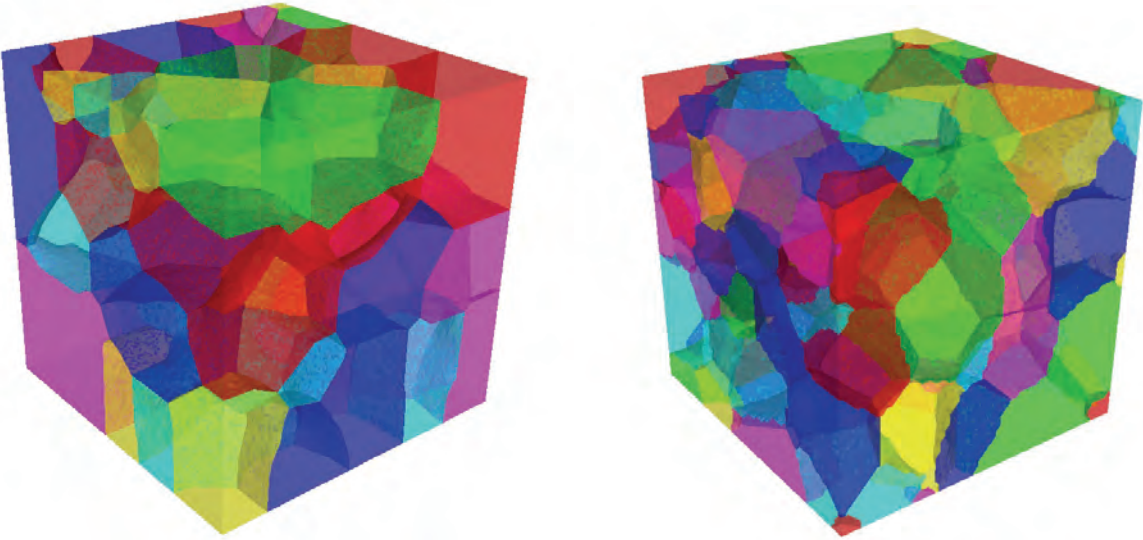


Figure 1: Finite element meshes (left) microstructure I, 50 grains (right) microstructure II, 126 grains [microstructures generated in collaboration with A.D. Rollett, Carnegie Mellon University]

Table 3: Finite element meshes of ceramic microstructures

Microstructure	No. grains	No. elements	Volume [mm ³]	Grain boundaries
I	50	1593788	8.0	smooth
II	126	1133743	1.0	rough

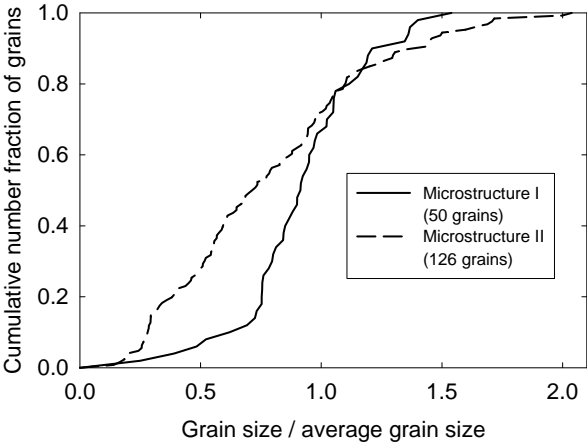


Figure 2: Normalized cumulative grain size distributions

5. SILICON CARBIDE: ELASTICITY AND DYNAMIC FRACTURE

A number of simulations using both microstructures (i.e., meshes) listed in Table 3 were conducted using properties of SiC listed in Tables 1 and 2. Simulations of SiC reported here prescribe linear elastic bulk behavior described by (6), with isotropic properties. Boundary conditions are assigned as follows. The microstructure (cube) is fixed along one surface (i.e., one face of the cube), and shear displacement is applied to the opposite face. Lateral sides remain traction-free. One of three additional conditions is simultaneously applied to the sheared face: (i) the face is left free to expand in the normal direction (referred to as free or unconfined shear), (ii) the face is fixed in the normal direction (referred to as fixed or confined shear), or (iii) the face is displaced in the normal direction causing simultaneous compression and shear (referred to as compression + shear). In all cases, the applied shear deformation rate $\dot{\gamma} = 10^5/s$. For compression + shear loading, the applied compressive strain rate is also $10^5/s$. Microstructures are assigned an initial velocity gradient that matches the applied boundary conditions so as to minimize elastic shocks that would arise if nodal velocities were increased from zero in a stepwise manner; however, release waves do originate from traction-free lateral boundaries. Simulations are listed in Table 4; both microstructures are considered. Different simulations for the same microstructure and boundary condition are delineated by shear loading in different directions. For example, forward and reverse loading on one of two orthogonal directions on each of three orthogonal faces of the cube provides up to twelve simulation cases.

Table 4: Numerical simulations of SiC microstructures

Simulation #	Microstructure	Boundary condition
1-4	I	free (unconfined) shear
5-8	I	fixed (confined) shear
9-12	I	compression + shear
13-24	II	free (unconfined) shear
25-36	II	fixed (confined) shear
37-48	II	compression + shear

Representative results from six simulations (one representative of each row in Table 4) are shown in Figure 3. Contours of the shear stress component work conjugate to the loading mode are shown for deformed meshes at an applied shear γ of 5%. Figure legends are truncated to best display the stress distribution; local maxima and minima at stress concentrations may exceed upper and lower bounds of the legends. Displacements are magnified to highlight trends in dynamic fracture behavior. The following results are noteworthy. Stress magnitude tends to increase with increasing confinement, as stress states progress in severity from (a) to (c) to (e) and (b) to (d) to (f). Microstructure I (50 grains) tends to support larger shear stresses, while fractures seem more pronounced for microstructure II (126 grains). For microstructure II, some grains are ejected from the specimen as fragmentation proceeds. For free shear boundary conditions (Figure 3(a) and (b)), shear stresses have relaxed except near a few critical locations at contact surfaces, and significant bending and dilatation are evident along the top (free surface), the latter phenomenon reminiscent of shear-induced porosity described by Shockey et al.² and Curran et al.³².

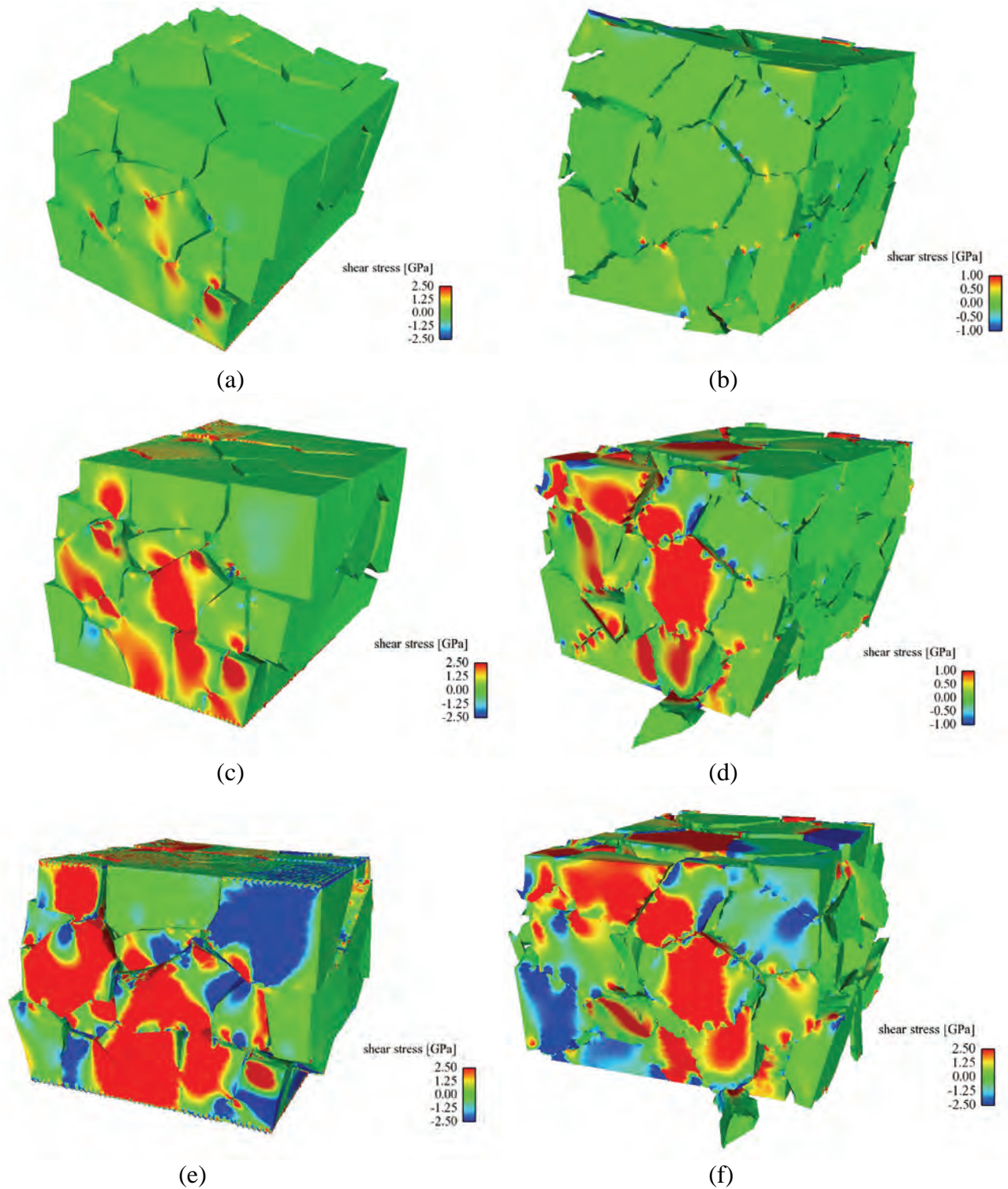


Figure 3: Shear stress in SiC microstructures at applied shear deformation γ of 5%: (a) microstructure I, free shear (b) microstructure II, free shear (c) microstructure I, fixed shear (d) microstructure II, fixed shear (e) microstructure I, compression + shear (f) microstructure II, compression + shear [displacement magnified 5 \times for (a)-(d); magnified 2 \times for (e)-(f)]

Figure 4 shows average applied shear stress τ and normal stress Σ , obtained from respective nodal reaction forces tangential and normal to the sheared face of the specimen. Results shown correspond to the six cases in Figure 3. Shear strength and normal stress both increase with confinement and further increase with applied compression. Normal stress is negligible for cases corresponding to free shear boundary conditions. Oscillations in shear stress arise as various fracture surfaces are activated, grains slide relative to one another, and sliding is impeded by constraints of neighboring grains or boundary conditions (for cases involving confinement). It is suggested that strength and pressure are greater in microstructure I because fewer, larger grains are favorably oriented for intergranular fracture, and hence fewer fracture sites are available to accommodate the imposed shear deformation. For the same reason, increased dilatation (i.e., bulking) would be expected for samples with fewer, larger grains since crack paths to achieve percolation across whole aggregates would be more tortuous.

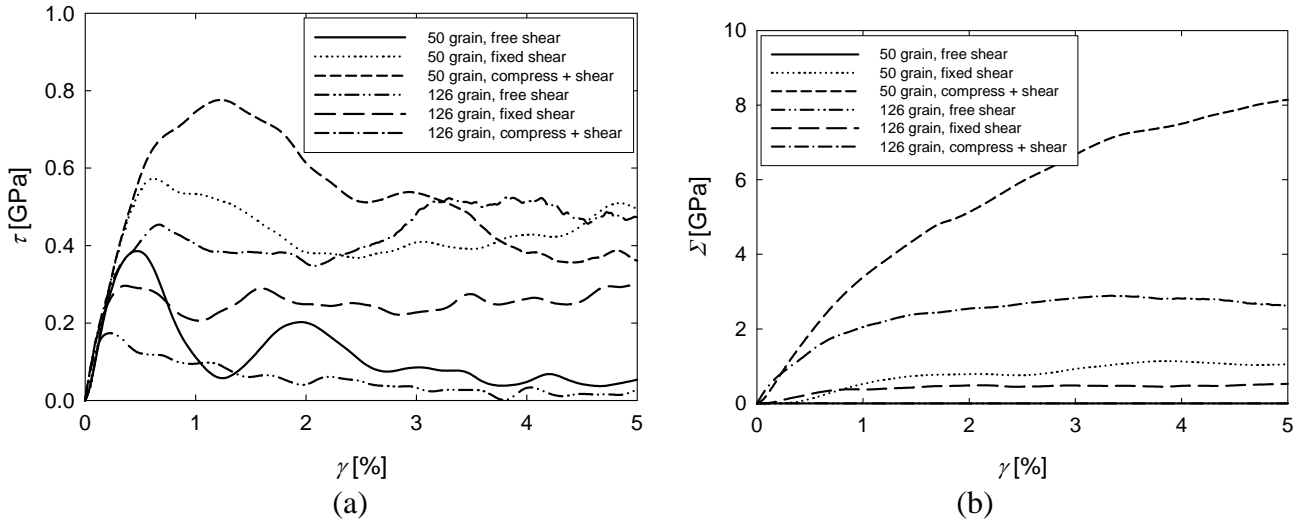


Figure 4: Average shear stress (a) and average normal stress (b) versus applied shear deformation for simulations of SiC microstructures shown in Figure 3

Figure 5(a) shows peak average shear strength $\sqrt{J_2}$ of each aggregate versus average pressure p . Results shown are for all simulations in Table 4 for which stable solutions were obtained. The peak shear strength was obtained at an applied strain level corresponding to the first local maxima in the simulation's average τ - γ curve (e.g., Figure 4(a)), i.e., when $\partial\tau/\partial\gamma=0$. Strength is computed via

$$J_2 = (\Sigma^2 + 3\tau^2)/3. \quad (10)$$

For both microstructures, shear strength appears to increase linearly with pressure. Slopes of each linear fit are nearly identical, but the strength intercept at zero pressure is lower for microstructure II. Extrapolation of each curve to null shear provides average hydrostatic tensile strengths of 0.23 GPa and 0.10 GPa for microstructures I and II, respectively. Average strengths can be lower than prescribed cohesive strengths because local fractures initiate and propagate early in the simulations as a result of mixed-mode loading (e.g., combined bending and shear) and inertial effects (e.g., release wave interactions) arising at high loading rates. Though the present results are limited in scope, a decrease in strength with increase in size (measured by number of grains) is apparent from Fig. 5(a). This trend of decreasing strength with increasing size has been reported for static flexure (ring crack) and Hertzian indentation experiments on SiC³³. The present results suggest that qualitatively similar trends may apply for smaller aggregates of material deformed dynamically at much higher rates.

Figure 5(b) shows peak average strength versus applied shear strain for all cases with free shear boundary conditions (i.e., no confining pressure). Stress relaxation at lateral boundaries and the

cohesive zone-contact model increase the apparent compliance of the aggregate relative to that of an elastic element of material deformed in simple shear (dotted line). Microstructure I (50 grains) exhibits a larger average strength and lower variation in strength (in terms of standard deviation) than microstructure II (126 grains). Static experiments³³ have similarly demonstrated higher characteristic strength and lower variation (i.e., higher Weibull modulus) as the sample size is decreased. Possible correlation between experimentally measured static strength projected to a low failure probability and ballistic performance has been noted³⁴; however, correlation of performance with grain size or hardness was not verified in those experiments. The present results suggest that a microstructure containing fewer, larger grains would provide superior dynamic shear strength, with less variation in failure strength, than would a microstructure with smaller, less equiaxed grains, were all other properties (e.g., elastic and interfacial behavior) held fixed. The former class of microstructure would have fewer grain boundary planes favorably oriented for fracture initiation and crack extension and percolation. However, the present computations omit the possibility of grain cleavage. A high purity SiC microstructure with larger grains would be more prone to transgranular fracture than would a microstructure with smaller grains and grain boundary impurities (e.g., SiC-N) that promote crack deflection and toughening^{30, 35}.

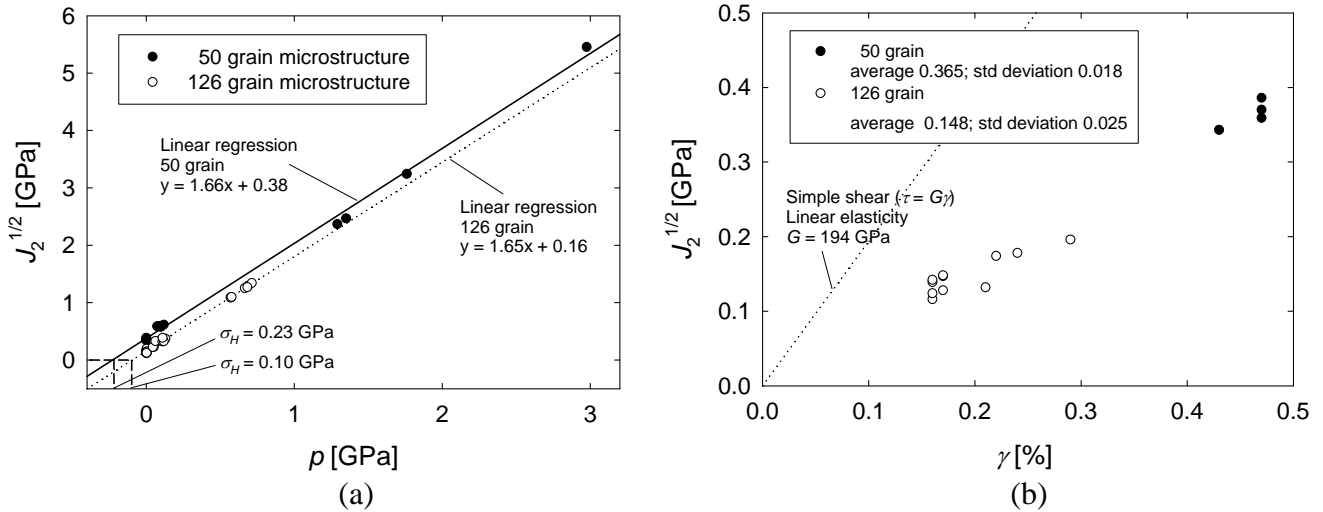


Figure 5: Average peak shear strength versus pressure for all SiC simulations (a) and average peak shear strength versus applied deformation for SiC simulations subjected to free (unconfined) shear (b)

6. ALON: ELASTICITY, PLASTICITY, AND DYNAMIC FRACTURE

A geometrically nonlinear anisotropic elastic-plastic model¹⁴ is used to represent behavior of AlON single crystals, corresponding to (2)-(4) and (7) and Tables 1 and 2. The isothermal version of the model used here considers only the primary slip mode: $\langle 110 \rangle \{ 111 \}$ dislocation glide, with up to twelve active, signed slip systems. Numerical implementation follows Dingreville et al.³⁶, modified to account for pressure-dependent cubic elastic coefficients. Results of two simulations are reported, as listed in Table 5. Boundary and initial conditions correspond to those discussed already for SiC polycrystals in Section 5. Stability and computational cost restrict the magnitude of deformation achieved in each simulation to $\sim 0.5\%$, which correlates with initiation of plastic yield.

Table 5: Numerical simulations of AlON microstructures

Simulation #	Microstructure	Boundary condition
1	I	free (unconfined) shear
2	I	fixed (confined) shear

Figure 6 shows that increased plastic slip activity—particularly in the vicinity of constrained grain boundaries—occurs in conjunction with confinement associated with fixed shear boundary conditions. Slip initiates due to stress concentrations from intergranular incompatibility (e.g., elastic anisotropy) and contact interactions. Figure 7 shows average shear and normal stresses computed from nodal reaction forces along the sheared (upper) face. Normal stress is negligible for free shear as the upper face is free to expand, but increases in response to bending, nonlinear elasticity (e.g., a Poynting effect¹⁸), and dilatation resisted by the fixed boundary. Shear stress and pressure for fixed shear loading begin to increase with loading, relative to the free boundary case, as early as 0.2 % shear deformation.

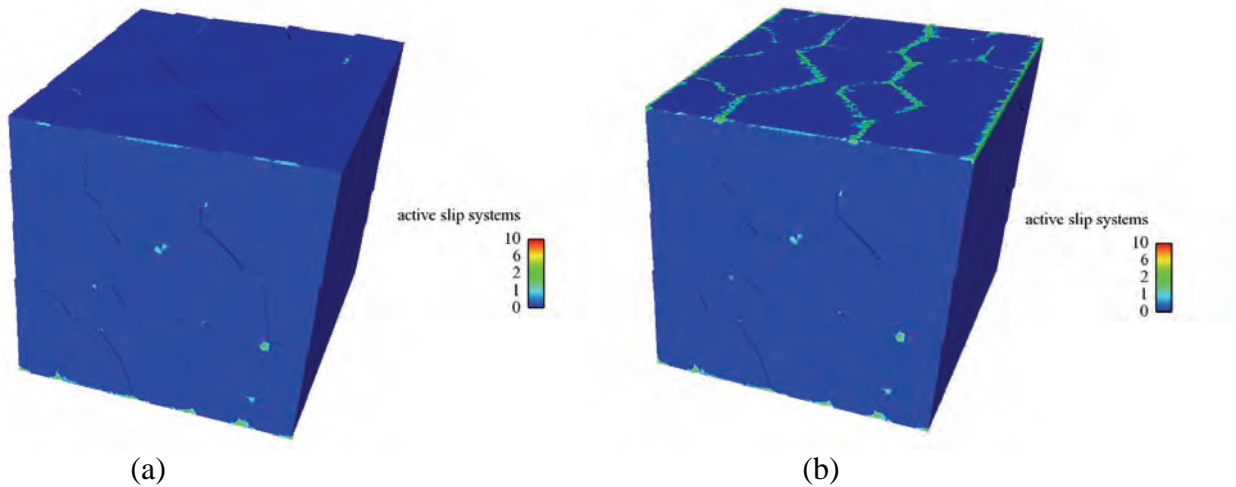


Figure 6: Number of active slip systems in AION polycrystal deformed under (a) free shear and (b) fixed (confined) shear [shear deformation γ of 0.45%; displacement magnified 20 \times]

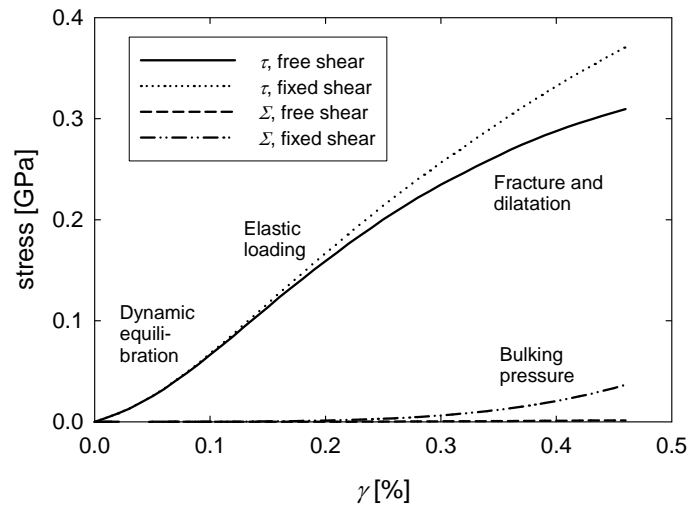


Figure 7: Average shear stress τ and normal stress Σ versus shear deformation for AION polycrystal

7. CONCLUSIONS

Mesoscale simulations have been conducted for SiC and AION polycrystals subjected to high strain rate shear loading ($10^5/s$) with varying confinement or superposed compression. Results of numerous simulations of SiC, idealized with linear elastic bulk behavior and uniform grain boundary fracture properties, suggest the following trends: (i) shear strength increases linearly with confining pressure and (ii) average shear strength is greater and statistical variation in strength lesser for microstructures with fewer, larger, more uniformly sized grains relative to those with more, smaller,

less uniformly sized grains. Pressure-dependent strength is correlated with shear-induced dilatancy, and such pressure dependence is significant despite the assumption of frictionless post-fracture grain boundary sliding. Variations in failure result only from grain geometry since constitutive properties are uniform. Results of dynamic simulations on AION demonstrate increased plastic slip initiation with increasing confinement, particularly in the vicinity of grain boundaries along confined surfaces.

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